

SD560B STANDARD RECTIFIER

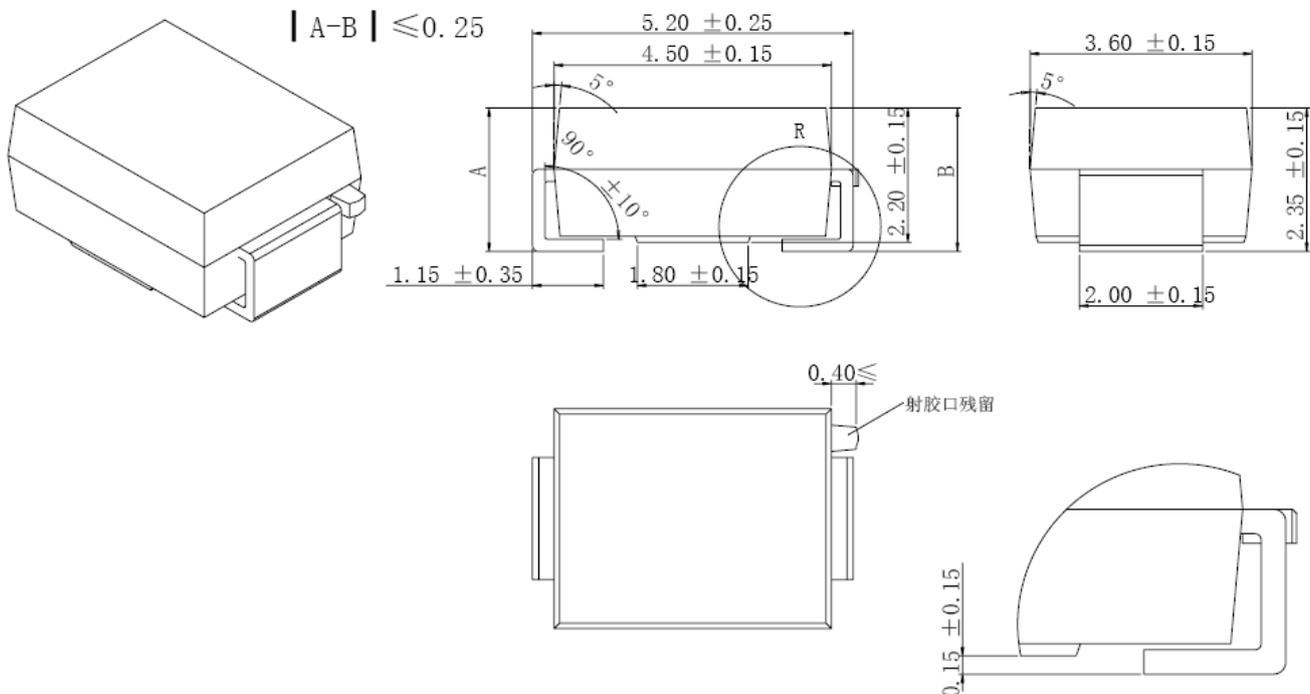
Features:

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Voltage Drop
- Surge Overload Rating to 200A Peak
- Low Power Loss
- Built Strain Relief
- Plastic Case Material has UL Flammability Classification Rating 94V-O
- This is a Pb - Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Mechanical data:

- Case: Molded Plastic
- Terminals: Solder Plated , Solderable Per MIL-STD 750 ,Method 2026
- Polarity: Cathode Band or Cathode Notch
- Marking: Type Number
- Weight: 0.68 grams(Approx)

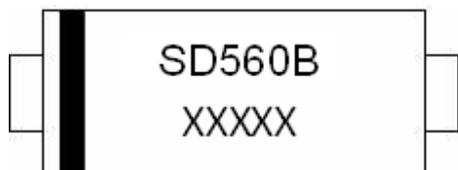
Mechanical Dimensions: In mm



SMB

Marking Diagram:

Where XXXXX is YYWWL



SD560B = Part Name
YY = Year
WW = Week
L = Lot Number

Cautions: Molding resin
Epoxy resin UL:94V-0

Ordering Information

Device	Package	Shipping
SD560B	SMB (Pb-Free)	3000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification.

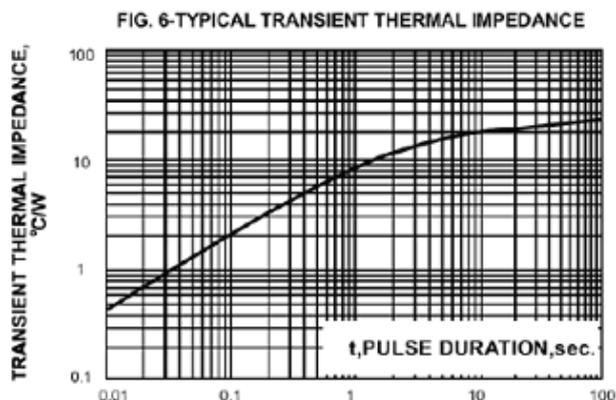
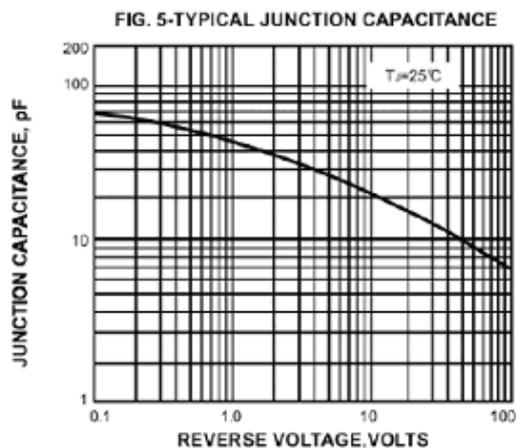
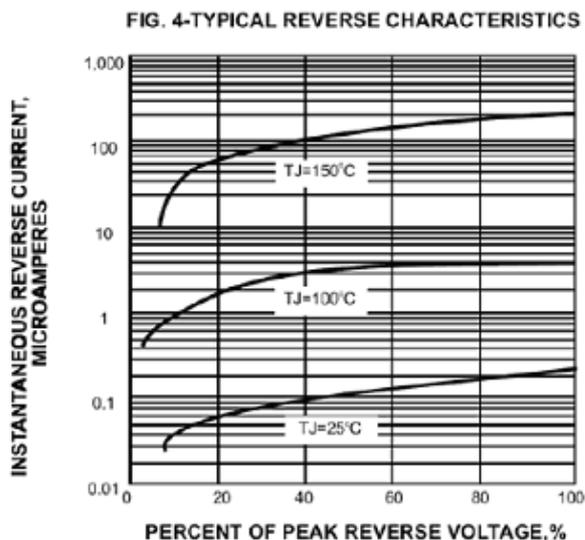
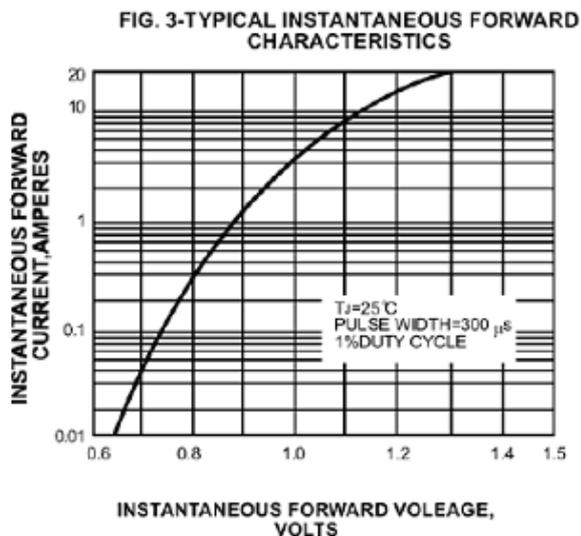
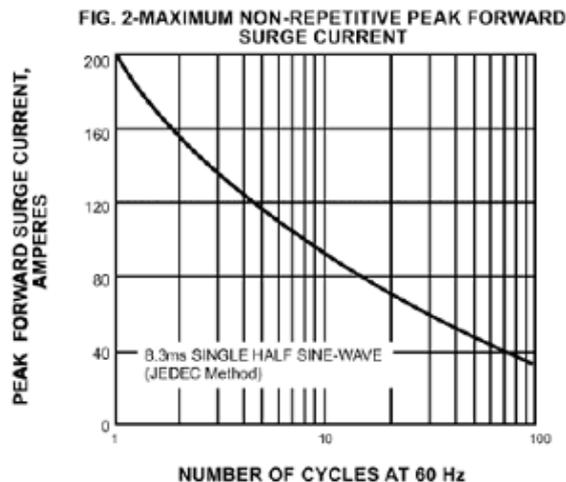
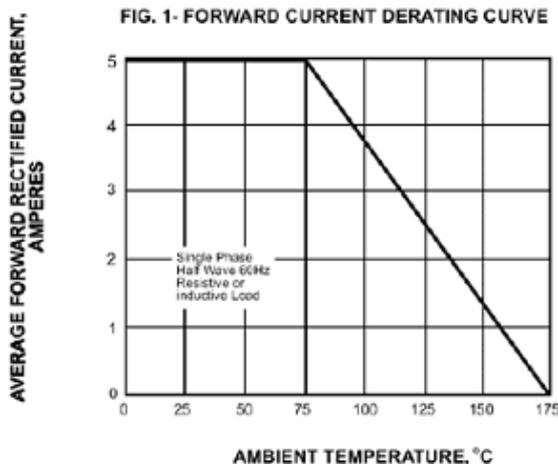
Maximum Ratings and Electrical Characteristics @T_A=25°C unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

Characteristic	Symbol	SD560B	Unit
Maximum Peak Repetitive Reverse Voltage Maximum DC Blocking Voltage	V _{RRM} V _{DC}	600	V
Maximum RMS Voltage	V _{RMS}	420	V
Maximum Average Forward Rectified Current 0.375"(9.5mm) Lead Length @T _A = 75°C	I _(AV)	5.0	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	200	A
I ² t Rating for fusing (t < 8.3ms)	I ² t	166	A ² S
Maximum Instantaneous Forward Voltage @I _F = 5.0A	V _F	1.2	V
Maximum DC Reverse Current At Rated DC Blocking Voltage	I _R	9.0 170	uA
Typical Junction Capacitance (Note 1)	C _j	50	pF
Typical Thermal Resistance (Note 2)	R _{θJA}	20	°C/W
Operating Storage Temperature Range	T _{STG}	-65 to +175	°C
Operating Junction Temperature	T _J	-65 to +175	°C
Case Style	SMB		

Note: 1. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.

2. Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length, P.C.B. mounted



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